MC14022B

Octal Counter

The MC14022B is a four–stage Johnson octal counter with built–in code converter. High–speed operation and spike–free outputs are obtained by use of a Johnson octal counter design. The eight decoded outputs are normally low, and go high only at their appropriate octal time period. The output changes occur on the positive–going edge of the clock pulse. This part can be used in frequency division applications as well as octal counter or octal decode display applications.

- Fully Static Operation
- DC Clock Input Circuit Allows Slow Rise Times
- Carry Out Output for Cascading
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low–power TTL Loads or One Low–power Schottky TTL Load Over the Rated Temperature Range
- Pin–for–Pin Replacement for CD4022B
- Triple Diode Protection on All Inputs

ON Semiconductor

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MARKING DIAGRAMS

PDIP–16
P SUFFIX
CASE 648

16
MC14022BCP
AWLYYWW
1

SOIC–16
D SUFFIX
CASE 751B

16
14022B
AWLYWW
1

A = Assembly Location
WL or L = Wafer Lot
YY or Y = Year
WW or W = Work Week

MAXIMUM RATINGS (Voltages Referenced to V_{SS}) (Note 1.)

Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage Range	−0.5 to +18.0	V
V_{in}, V_{out}	Input or Output Voltage Range (DC or Transient)	−0.5 to V_{DD} + 0.5	V
I_{in}, I_{out}	Input or Output Current (DC or Transient) per Pin	±10	mA
P_D	Power Dissipation, per Package (Note 2.)	500	mW
T_A	Ambient Temperature Range	−55 to +125	°C
T_{stg}	Storage Temperature Range	−65 to +150	°C
T_L	Lead Temperature (8–Second Soldering)	260	°C

1. Maximum Ratings are those values beyond which damage to the device may occur.
2. Temperature Derating:
   Plastic "P and D/DW" Packages: – 7.0 mW/°C From 65°C To 125°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in}$ or $V_{out}) \leq V_{DD}$.
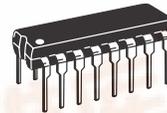
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.
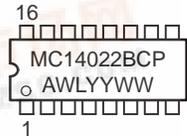
ORDERING INFORMATION

Device	Package	Shipping
MC14022BCP	PDIP–16	2000/Box
MC14022BD	SOIC–16	2400/Box
MC14022BDR2	SOIC–16	2500/Tape & Reel

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PIN ASSIGNMENT

```
        ┌───────┐
Q1 ┤  1 ●    16 ├ V_DD
Q0 ┤  2      15 ├ R
Q2 ┤  3      14 ├ C
Q5 ┤  4      13 ├ CE
Q6 ┤  5      12 ├ C_out
NC ┤  6      11 ├ Q4
Q3 ┤  7      10 ├ Q7
V_SS ┤ 8       9 ├ NC
        └───────┘
```
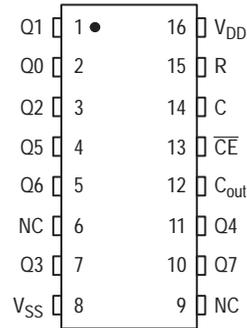
NC = NO CONNECTION

BLOCK DIAGRAM

CLOCK 14

$\overline{CLOCK}$ $\overline{ENABLE}$ 13

RESET 15

Q0	2
Q1	1
Q2	3
Q3	7
Q4	11
Q5	4
Q6	5
Q7	10
C_out	12

V_DD = PIN 16
V_SS = PIN 8
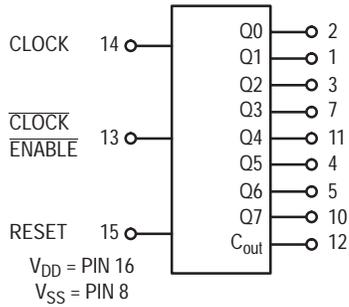
NC = PIN 6, 9

FUNCTIONAL TRUTH TABLE
(Positive Logic)

Clock	Clock $\overline{Enable}$	Reset	Output=n
0	X	0	n
X	1	0	n
⌐_	0	0	n+1
‾⌐	X	0	n
1	⌐‾	0	n+1
X	_⌐	0	n
X	X	1	Q0

X = Don't Care. If n < 4 Carry = 1,
Otherwise = 0.

LOGIC DIAGRAM

CLOCK 14

13 $\overline{CLOCK}$ $\overline{ENABLE}$

15 RESET

V_DD

V_SS

11 Q4   1 Q1   5 Q6   7 Q3

CARRY 12

Q0 2   Q5 4   Q2 3   Q7 10
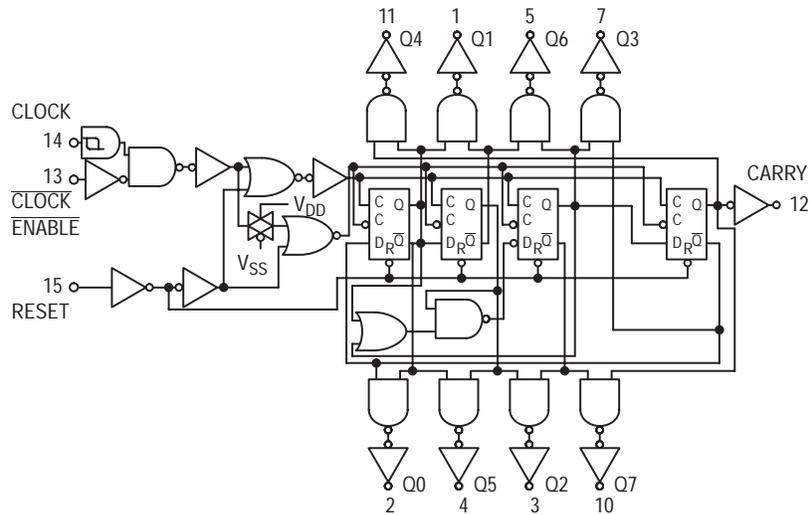
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ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic		Symbol	V_{DD} Vdc	−55°C		25°C			125°C		Unit
				Min	Max	Min	Typ [3.]	Max	Min	Max	
Output Voltage "0" Level $V_{in} = V_{DD}$ or 0		V_{OL}	5.0	—	0.05	—	0	0.05	—	0.05	Vdc
			10	—	0.05	—	0	0.05	—	0.05	
			15	—	0.05	—	0	0.05	—	0.05	
"1" Level $V_{in} = 0$ or V_{DD}		V_{OH}	5.0	4.95	—	4.95	5.0	—	4.95	—	Vdc
			10	9.95	—	9.95	10	—	9.95	—	
			15	14.95	—	14.95	15	—	14.95	—	
Input Voltage "0" Level (V_O = 4.5 or 0.5 Vdc) (V_O = 9.0 or 1.0 Vdc) (V_O = 13.5 or 1.5 Vdc)		V_{IL}	5.0	—	1.5	—	2.25	1.5	—	1.5	Vdc
			10	—	3.0	—	4.50	3.0	—	3.0	
			15	—	4.0	—	6.75	4.0	—	4.0	
"1" Level (V_O = 0.5 or 4.5 Vdc) (V_O = 1.0 or 9.0 Vdc) (V_O = 1.5 or 13.5 Vdc)		V_{IH}	5.0	3.5	—	3.5	2.75	—	3.5	—	Vdc
			10	7.0	—	7.0	5.50	—	7.0	—	
			15	11	—	11	8.25	—	11	—	
Output Drive Current (V_{OH} = 2.5 Vdc) Source (V_{OH} = 4.6 Vdc) (V_{OH} = 9.5 Vdc) (V_{OH} = 13.5 Vdc)		I_{OH}	5.0	− 3.0	—	− 2.4	− 4.2	—	− 1.7	—	mAdc
			5.0	− 0.64	—	− 0.51	− 0.88	—	− 0.36	—	
			10	− 1.6	—	− 1.3	− 2.25	—	− 0.9	—	
			15	− 4.2	—	− 3.4	− 8.8	—	− 2.4	—	
(V_{OL} = 0.4 Vdc) Sink (V_{OL} = 0.5 Vdc) (V_{OL} = 1.5 Vdc)		I_{OL}	5.0	0.64	—	0.51	0.88	—	0.36	—	mAdc
			10	1.6	—	1.3	2.25	—	0.9	—	
			15	4.2	—	3.4	8.8	—	2.4	—	
Input Current		I_{in}	15	—	± 0.1	—	±0.00001	± 0.1	—	± 1.0	µAdc
Input Capacitance (V_{in} = 0)		C_{in}	—	—	—	—	5.0	7.5	—	—	pF
Quiescent Current (Per Package)		I_{DD}	5.0	—	5.0	—	0.005	5.0	—	150	µAdc
			10	—	10	—	0.010	10	—	300	
			15	—	20	—	0.015	20	—	600	
Total Supply Current [4.] [5.] (Dynamic plus Quiescent, Per Package) (C_L = 50 pF on all outputs, all buffers switching)		I_T	5.0 10 15	$I_T = (0.28\ \mu A/kHz)f + I_{DD}$ $I_T = (0.56\ \mu A/kHz)f + I_{DD}$ $I_T = (0.85\ \mu A/kHz)f + I_{DD}$							µAdc

3. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
4. The formulas given are for the typical characteristics only at 25°C.
5. To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50\ pF) + (C_L − 50)\ Vfk$$

where: I_T is in µA (per package), C_L in pF, $V = (V_{DD} − V_{SS})$ in volts, f in kHz is input frequency, and k = 0.00125.

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SWITCHING CHARACTERISTICS [6.] (C_L = 50 pF, T_A = 25°C)

Characteristic	Symbol	V_{DD} Vdc	Min	Typ [7.]	Max	Unit
Output Rise and Fall Time t_{TLH}, t_{THL} = (1.5 ns/pF) C_L + 25 ns t_{TLH}, t_{THL} = (0.75 ns/pF) C_L + 12.5 ns t_{TLH}, t_{THL} = (0.55 ns/pF) C_L + 9.5 ns	t_{TLH}, t_{THL}	5.0 10 15	— — —	100 50 40	200 100 80	ns
Propagation Delay Time Reset to Decode Output t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 415 ns t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 197 ns t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 150 ns	t_{PLH}, t_{PHL}	5.0 10 15	— — —	500 230 175	1000 460 350	ns
Propagation Delay Time Clock to C_{out} t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 315 ns t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 142 ns t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 100 ns	t_{PLH}, t_{PHL}	5.0 10 15	— — —	400 175 125	800 350 250	ns
Propagation Delay Time Clock to Decode Output t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 415 ns t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 197 ns t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 150 ns	t_{PLH}, t_{PHL}	5.0 10 15	— — —	275 125 95	1000 460 350	ns
Turn–Off Delay Time Reset to C_{out} t_{PLH} = (1.7 ns/pF) C_L + 315 ns t_{PLH} = (0.66 ns/pF) C_L + 142 ns t_{PLH} = (0.5 ns/pF) C_L + 100 ns	t_{PLH}	5.0 10 15	— — —	400 175 125	800 350 250	ns
Clock Pulse Width	t_{WH}	5.0 10 15	250 100 75	125 50 35	— — —	ns
Clock Frequency	f_{cl}	5.0 10 15	— — —	5.0 12 16	2.0 5.0 6.7	MHz
Reset Pulse Width	t_{WH}	5.0 10 15	500 250 190	250 125 95	— — —	ns
Reset Removal Time	t_{rem}	5.0 10 15	750 275 210	375 135 105	— — —	ns
Clock Input Rise and Fall Time	t_{TLH}, t_{THL}	5.0 10 15	\ No Limit			—
Clock Enable Setup Time	t_{su}	5.0 10 15	350 150 115	175 75 52	— — —	ns
Clock Enable Removal Time	t_{rem}	5.0 10 15	420 200 140	260 100 70	— — —	ns

6. The formulas given are for the typical characteristics only at 25°C.
7. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
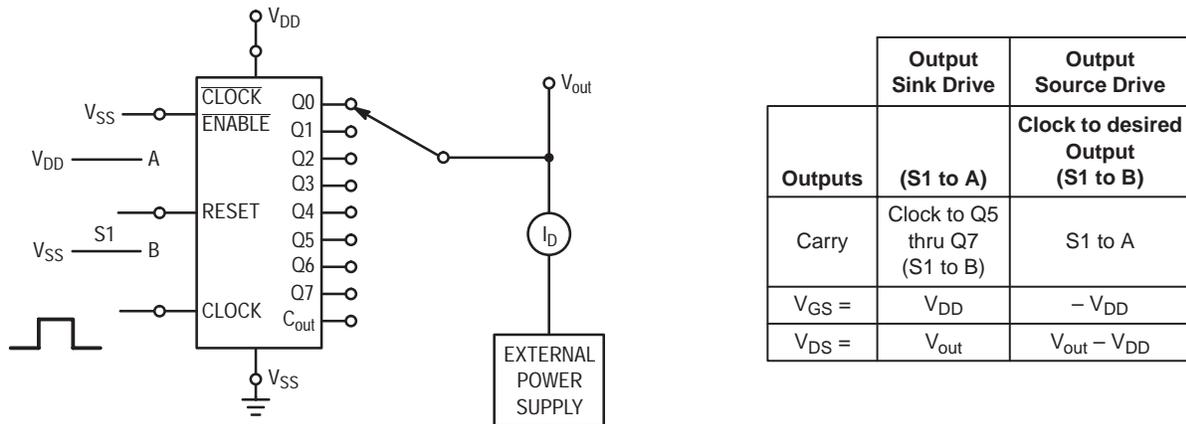
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	Output Sink Drive	Output Source Drive
		Clock to desired Output
Outputs	**(S1 to A)**	**(S1 to B)**
Carry	Clock to Q5 thru Q7 (S1 to B)	S1 to A
$V_{GS} =$	V_{DD}	$- V_{DD}$
$V_{DS} =$	V_{out}	$V_{out} - V_{DD}$

Figure 1. Typical Output Source and Output Sink Characteristics Test Circuit
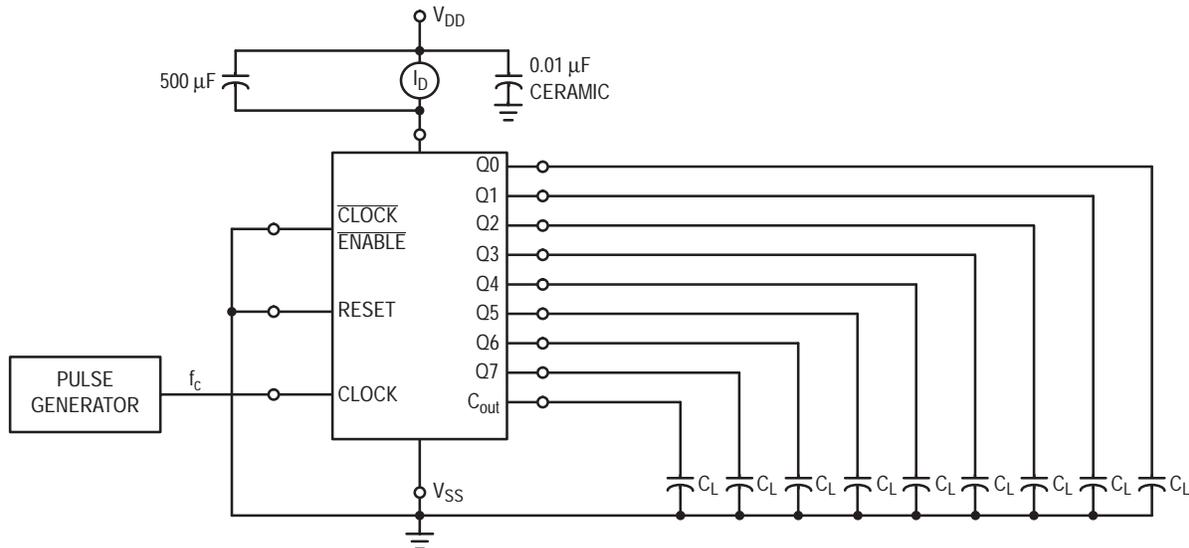
Figure 2. Typical Power Dissipation Test Circuit

APPLICATIONS INFORMATION

Figure 3 shows a technique for extending the number of decoded output states for the MC14022B. Decoded outputs are sequential within each stage and from stage to stage, with no dead time (except propagation delay).
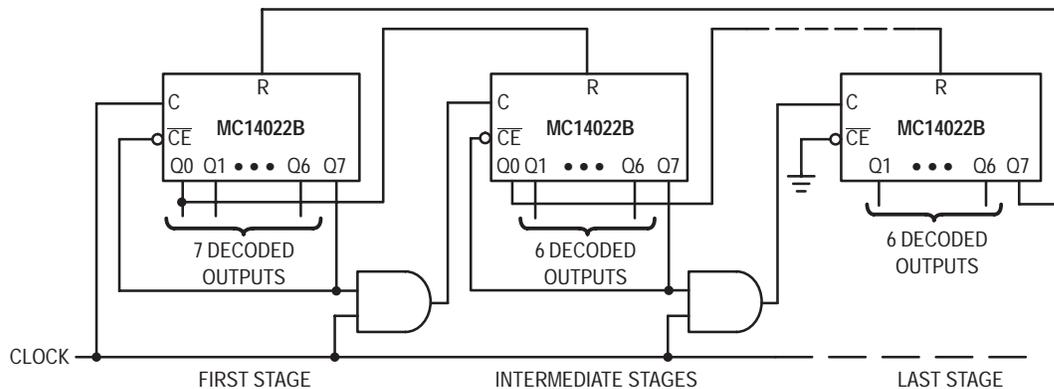
Figure 3. Counter Expansion

MC14022B
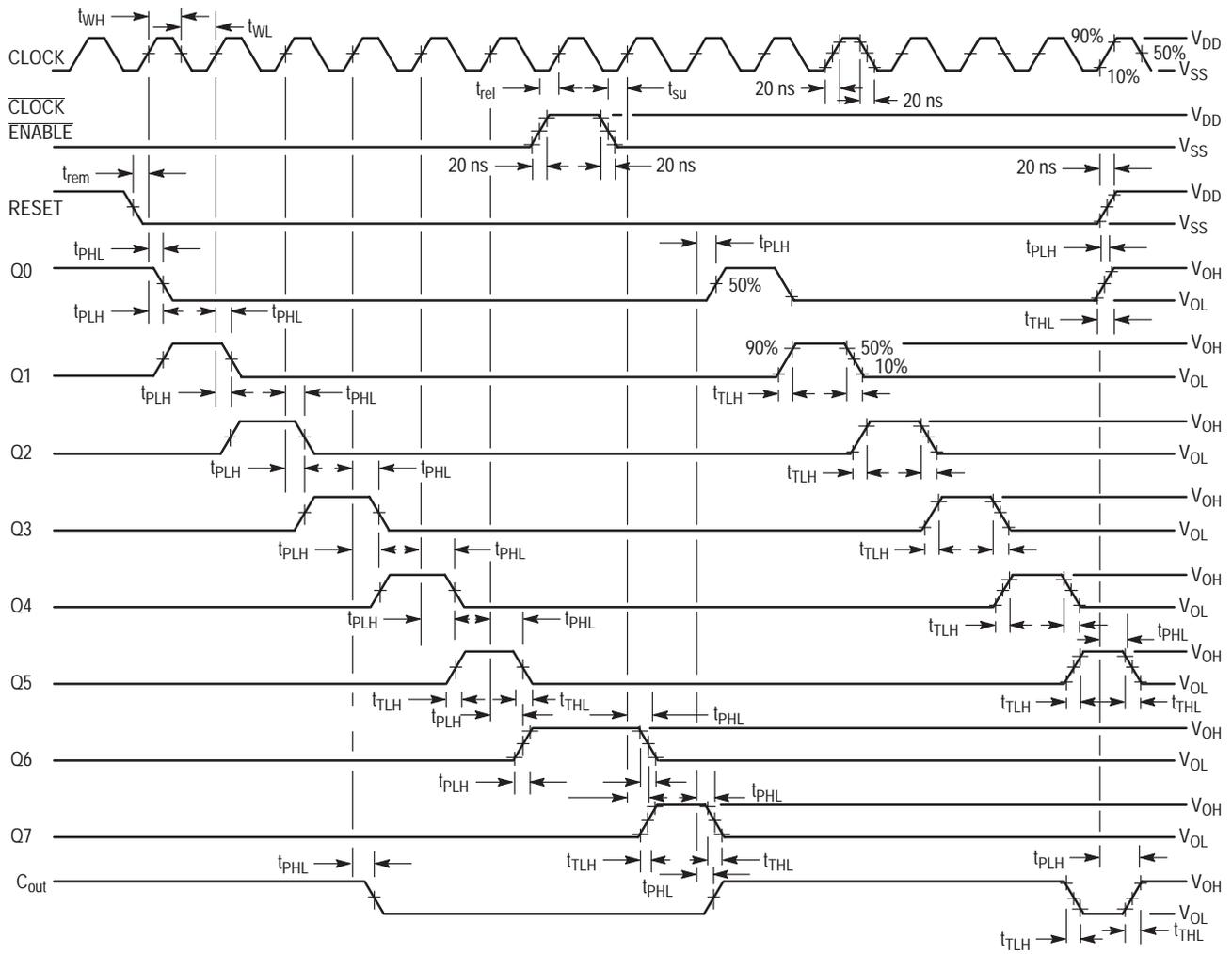
Figure 4. AC Measurement Definition and Functional Waveforms

MC14022B

PACKAGE DIMENSIONS

PDIP–16
P SUFFIX
PLASTIC DIP PACKAGE
CASE 648–08
ISSUE R
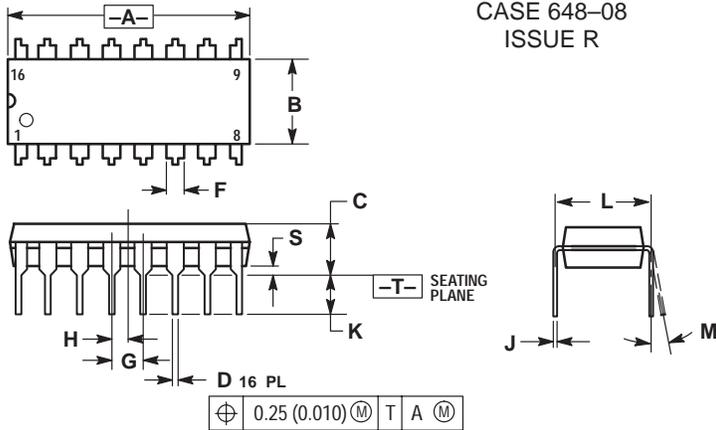
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0 °	10 °	0 °	10 °
S	0.020	0.040	0.51	1.01

⊕ | 0.25 (0.010) Ⓜ | T | A Ⓜ

SOIC–16
D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751B–05
ISSUE J
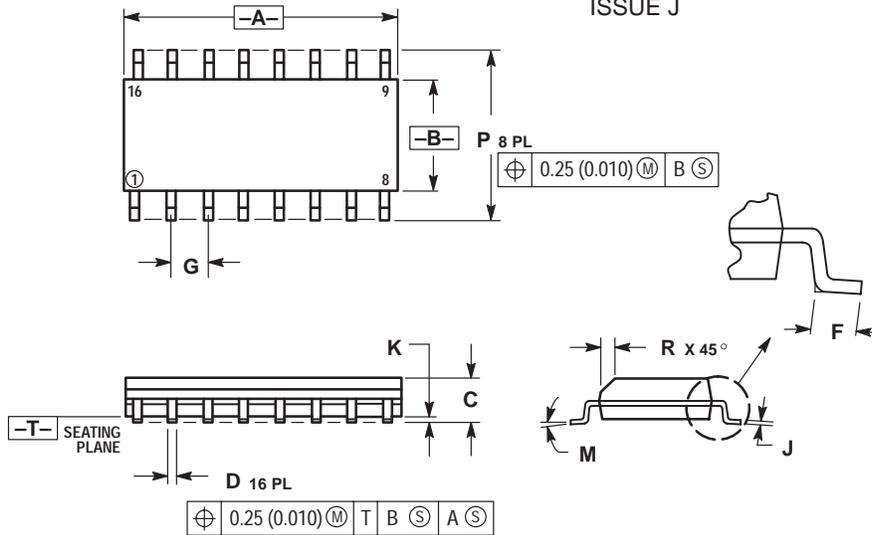
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

⊕ | 0.25 (0.010) Ⓜ | B Ⓢ

R X 45 °

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0 °	7 °	0 °	7 °
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

⊕ | 0.25 (0.010) Ⓜ | T | B Ⓢ | A Ⓢ

MC14022B

PACKAGE DIMENSIONS

SOEIAJ–16
F SUFFIX
PLASTIC EIAJ SOIC PACKAGE
CASE 966–01
ISSUE O
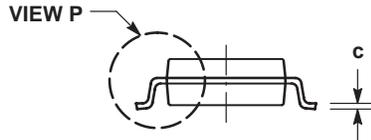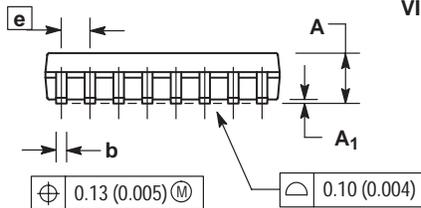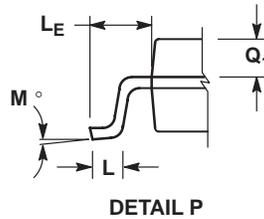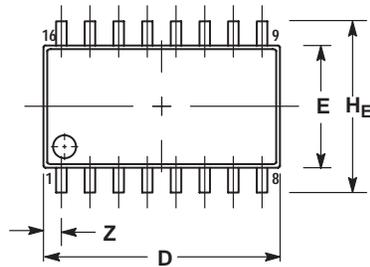
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	–––	2.05	–––	0.081
A_1	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H_E	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L_E	1.10	1.50	0.043	0.059
M	0 °	10 °	0 °	10 °
Q_1	0.70	0.90	0.028	0.035
Z	–––	0.78	–––	0.031

PUBLICATION ORDERING INFORMATION